

REMARKS

The pending claims are rejected in paragraph 2 under Section 112 for lack of enablement.

However, the application explains in both the abstract and at page 4, line 32 through page 5, line 5, that resinous material is forced through the stencil 10 so that, as shown in Figure 2, the material extends downwardly and laterally under the central portion of the stencil 10 and to either side of the openings through the stencil. Therefore, one skilled in the art would readily appreciate that one way to deposit the material under the stencil is to leave a gap between the stencil and the supporting surface and to force the material through the holes in the stencil so that the material goes underneath the stencil.

Anyone who has attempted to spray paint using a stencil will appreciate that if the stencil is not pressed very tightly against the supporting surface, the material proceeds underneath the stencil. Certainly, one skilled in the semiconductor art would appreciate that by forcing resinous material through holes in a stencil spaced over a surface, that the material would end up between the stencil and the surface as shown in Figure 2.

Therefore, reconsideration of the Section 112 rejection is respectfully requested.

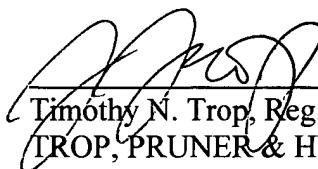
With respect to the rejections set forth in paragraph 3, it is noted that the specification is not silent. The element is described in the above-cited material as shown in the figures. Reconsideration is requested.

With respect to the rejection of claim 39, it is stated that make the scope of the claim unclear because they direct it to method of placing material by using the stencil instead of the method of making the stencil alone. It is noted that the preamble of claim 34 calls for a method of making a stencil which may be removably positioned over a semiconductor device when depositing material in the semiconductor before removing the stencil from over the device. However, claim 34 has been amended to remove the preamble. Therefore, any such confusion should be thereby clarified.

In view of these remarks, reconsideration is requested.

Respectfully submitted,

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